CD54AC157...F PACKAGE CD74AC157...E OR M PACKAGE

(TOP VIEW)

1A [] 2 1B [] 3

4

5

8

Ā/B

1Υ **Π**

2A 🛛

2B 🛛 6

2Y [] 7

GND [

16 V_{CC}

15 G

14**1** 4A

13 4B

12 4Y

11 3A

10 3B

9 3Y

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- AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply Voltage
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- ±24-mA Output Drive Current
 Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015

description	/ordering	information
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These quadruple 2-line to 1-line data selectors/multiplexers are designed for 1.5-V to 5.5-V V_{CC} operation.

The 'AC157 devices feature a common strobe (\overline{G}) input. When the strobe is high, all outputs are low. When the strobe is low, a 4-bit word is selected from one of two sources and is routed to the four outputs. The devices provide true data.

|--|

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – E	Tube	CD74AC157E	CD74AC157E
–55°C to 125°C	SOIC – M	Tube	CD74AC157M	AC157M
		Tape and reel	CD74AC157M96	ACTOTIN
	CDIP – F Tube CD54AC157F3A		CD54AC157F3A	CD54AC157F3A

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	INPU	JTS		OUTPUT
G	Ā/B	Α	В	Y
н	Х	Х	Х	L
L	L	L	х	L
L	L	Н	х	н
L	Н	Х	L	L
L	н	Х	н	н

FUNCTION TABLE



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

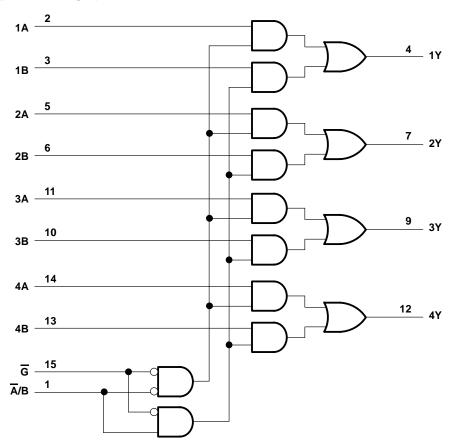
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2003, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	–0.5 V to 6 V
Input clamp current, I_{IK} ($V_I < 0$ V or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I _{OK} (V _O < 0 V or V _O > V _{CC}) (see Note 1)	±50 mA
Continuous output current, I _O (V _O > 0 V or V _O < V _{CC})	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2): E package	67°C/W
M package	73°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

			T _A = 25°C		–55°(125		–40°C to 85°C		UNIT	
			MIN	MAX	MIN	MAX	MIN	MAX		
VCC	Supply voltage		1.5	5.5	1.5	5.5	1.5	5.5	V	
		V _{CC} = 1.5 V	1.2		1.2		1.2			
VIH	High-level input voltage	$V_{CC} = 3 V$	2.1		2.1		2.1		V	
		V _{CC} = 5.5 V	3.85		3.85		3.85			
	Low-level input voltage	V _{CC} = 1.5 V		0.3		0.3		0.3		
VIL		$V_{CC} = 3 V$		0.9		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		1.65		
VI	Input voltage		0	VCC	0	VCC	0	VCC	V	
٧O	Output voltage		0	VCC	0	VCC	0	VCC	V	
IОН	High-level output current	V _{CC} = 4.5 V to 5.5 V		-24		-24		-24	mA	
IOL	Low-level output current	V_{CC} = 4.5 V to 5.5 V		24		24		24	mA	
A+/A.v	Input transition rise or fall rate	V _{CC} = 1.5 V to 3 V		50		50		50	n o//	
$\Delta t / \Delta v$	Input transition rise or fall rate	V _{CC} = 3.6 V to 5.5 V		20		20		20	ns/V	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vcc	T _A = 25°C		–55°C to 125°C		–40°C to 85°C		UNIT
				MIN MAX		MIN	MAX	MIN	MAX	
			1.5 V	1.4		1.4		1.4		
		I _{OH} = -50 μA	3 V	2.9		2.9		2.9		
			4.5 V	4.4		4.4		4.4		
∨он	$V_I = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -4 \text{ mA}$	3 V	2.58		2.4		2.48		V
		I _{OH} = -24 mA	4.5 V	3.94		3.7		3.8		
		$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V			3.85				
		I _{OH} = -75 mA†	5.5 V					3.85		
			1.5 V		0.1		0.1		0.1	
		I _{OL} = 50 μA	3 V		0.1		0.1		0.1	
			4.5 V		0.1		0.1		0.1	
VOL	$V_I = V_{IH} \text{ or } V_{IL}$	I _{OL} = 12 mA	3 V		0.36		0.5		0.44	V
		I _{OL} = 24 mA	4.5 V		0.36		0.5		0.44	
		$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V				1.65			
		I _{OL} = 75 mA [†]	5.5 V						1.65	
lı	$V_I = V_{CC} \text{ or } GND$		5.5 V		±0.1		±1		±1	μA
ICC	$V_I = V_{CC}$ or GND,	I ^O = 0	5.5 V		8		160		80	μA
Ci					10		10		10	pF

[†] Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.



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switching characteristics over recommended operating free-air temperature range, $V_{CC} = 1.5 \text{ V}$, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	то (оитрит)	–55°C to 125°C		–40°(85°	UNIT	
		(001F01)	MIN	MAX	MIN	MAX	
^t PLH	A or B	Any Y		106		97	20
^t PHL	AUB			106		97	ns
^t PLH	Ā/B	Any Y		180		164	ns
^t PHL	А/В			180		164	115
^t PLH	IJ	Any Y		169		154	ns
^t PHL	9			169		154	115

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	ARAMETER FROM TO (INPUT) (OUTPUT)	_	–55° 125		–40°(85°	UNIT	
		MIN	MAX	MIN	MAX		
^t PLH	A or B	Any V	3	11.9	3.2	10.8	ns
^t PHL	AOIB	Any Y	3	11.9	3.2	10.8	115
^t PLH	Ā/B	Any Y	5.1	20.3	5.4	18.5	ns
^t PHL	A/B		5.1	20.3	5.4	18.5	115
^t PLH	G	Any Y	4.7	18.9	5.1	17.2	ns
^t PHL	0		4.7	18.9	5.1	17.2	115

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

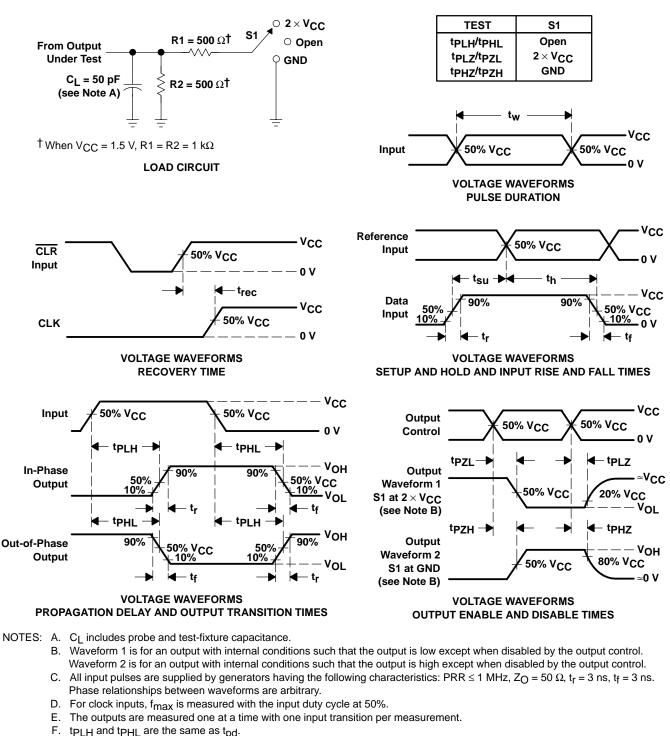
PARAMETER	FROM	ТО (О U ТРUТ)	–55° 125		–40°(85°	UNIT	
	(INPUT)	(001F01)	MIN	MAX	MIN	MAX	
^t PLH	A or B		2.1	8.5	2.2	7.7	
^t PHL	AOIB	Any Y	2.1	8.5	2.2	7.7	ns
^t PLH	Ā/B		3.6	14.5	3.8	13.2	
^t PHL	A/B	Any Y	3.6	14.5	3.8	13.2	ns
^t PLH	G	Any Y	3.4	13.5	3.6	12.3	ns
^t PHL	Ø		3.4	13.5	3.6	12.3	115

operating characteristics, V_{CC} = 5 V, T_A = 25° C

	PARAMETER	TYP	UNIT
C _{pd}	Power dissipation capacitance	156	pF



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PARAMETER MEASUREMENT INFORMATION

- G. tp71 and tp7H are the same as ten.
- H. tpLz and tpHz are the same as tdis.
- I. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

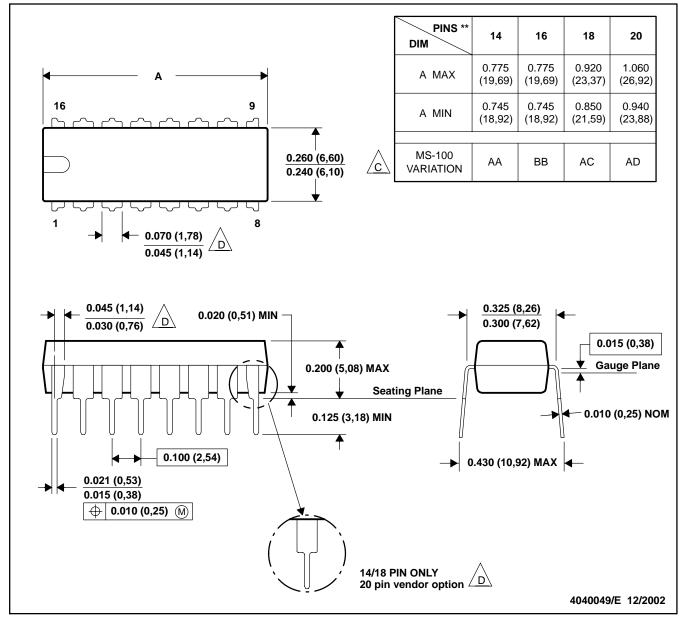
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MPDI002C - JANUARY 1995 - REVISED DECEMBER 20002

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

/д.

B. This drawing is subject to change without notice.

/C Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

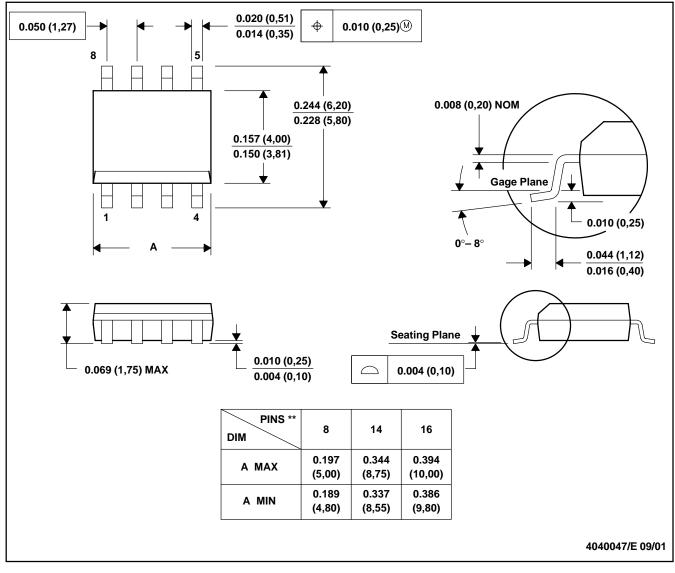


MECHANICAL DATA

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

D (R-PDSO-G**) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012



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